

Advanced Test Equipment Rentals www.atecorp.com 800-404-ATEC (2832)

Temperature Range¹ -20° to +225°C

Temperature Display and Resolution0.1°CTemperature Accuracy±1°C (V

 $0.1^{\circ}C$ ±1°C (When calibrated against

NIST Transfer Standard)



Facilities Preparation

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| Power Requirements ¹ | 115V AC ±10%, 50 or 60 Hz, 1 ø, 15 amp 230V AC ±10%, 50 or 60 Hz, 1 ø, 10 amp | |
| Compressed Air Supply Pressure ² | 5.6 to 7 kg /cm² (80 to 90 PSIG), 5.6 kg/cm² (80 PSIG) nominal | |
| Supply Airflow at Nominal Supply Pressure ² | 4 to 5 liters/second (8-10 scfm) 4.5 l/s (9 scfm) nominal | |
| Dewpoint ³ | ambient to -40°C | |
| Air Supply Temperature | +20° to +28°C (+22°C nominal ¹) | |
| Operating Temperature (Ambient) | +20° to +28°C (+22°C nominal ¹) | |
| Humidity | 0 to 60% (45% nominal ¹) | |
| Noise Level | ≤ 70 dBA | |
| Power Connection | Standard male IEC320 power connector socket for attachment of IEC320 power cord (meets IEC requirements). Power cord (2.4 meters in length) included. | |

¹Reduced performance may be encountered at operating conditions less than or greater than nominal. ²Requires clean, dry air supply. ³-40°C dewpoint is nominal for low temperature testing for extended periods.

Dimensions and Weight

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| Dimensions: | Controller: 40.1 cm (15.8 inches) wide x 14.8 cm (5.8 inches) high x 48.9 cm (19.2 inches) deep | |
| Thermal Wand: | 8 cm (3 inches) in diameter x 36 cm (14 inches) long | |
| Stand: | 48.25 cm (19 inches) approximately above tabletop to top of post Reach from vertical post: Standard: 51 cm (20 inches) | |
| Weight: | Controller with Thermal Wand and Hose14.5 kg (32 lbs)Thermal Wand Stand Assembly7 kg (15.5 lbs)Thermal Cap.45 kg (1 lb) | |

Options and Accessories

| Thermal Wand Stand Assembly | Expanding, locking stand assembly rotates 340° about the controller cabinet for positioning the Thermal Wand directly over the DUT. | |
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| Benchmount Stand Assembly | Attaches the Thermal Wand Stand Assembly directly to a bench. Can be mounted up to 30.5 cm (12 inches) from controller chassis. | |
| Thermal Cap | Transparent single wall glass cap of approximately 9.9 cm (3.9 inches) ID (Internal Diameter); includes metal guard. | |
| Shroud Kit | Shroud attaches to thermal wand for coupling to devices. Kit contains a variety of sizes and shapes (See price list). Available in conductive and non-conductive material. | |
| Insulation Kit | Non-conductive silicone foam rubber sheets. Three sheets: (12" x 12" x .125"), (12" x 12" x .25"), (12" x 12" x .5") | |
| Custom Thermal Test Enclosures and ThermoFixture® | Frost-free thermal enclosures for testing ICs, hybrids, modules and small subassemblies precise temperature in a moisture-free thermal environment. Available in standard and custom configurations. ThermoFixture can include ATE interface. | |
| Pneumatic Wand Lift Assembly | Automates the raising and lowering of the Thermal Wand for the loading and unloading of the DUT. | |

The Thermal Wand may be operated in-hand or secured in the optional **Thermal Wand Stand Assembly** for added stability and hands-free operation. Mounted directly to the TPO4100A controller cabinet, the Stand Assembly rotates over 340°, and expands and locks for stable, proper coupling of the Thermal Wand to the DUT. The optional Benchmount Stand Assembly attaches to the bench to hold the Thermal Wand Stand Assembly. The Thermal Wand may then be used while secured in the stand for stability during test while located conveniently at the bench.

To protect from moisture condensation and frost at the DUT site, the optional single-wall glass **Thermal Cap** may be attached to the Thermal Wand with the shrouds. The Thermal Cap is approximately 9.9 cm (3.9 inches) ID and includes a metal guard. Additional conductive and non-conductive sheets and shrouds in various sizes and shapes are also optional.

For frost-free thermal testing of ICs, hybrids, modules and small subassemblies in a precisely controlled thermal environment, **ThermoFixture**[®] and **Custom Thermal Test Enclosures** are available. ThermoFixture enclosures include the complete ATE tester interface and DUT thermal control for moisture-free testing at low temperatures even over longer test periods.



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